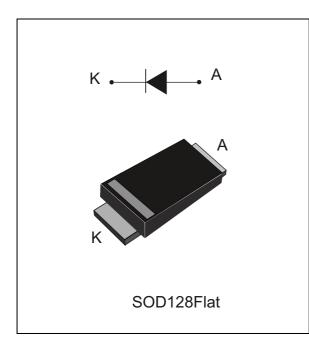


STTH3R02-Y

Automotive ultrafast rectifier

Datasheet - production data



Description

The STTH3R02-Y, implementing ST's new 200 V planar technology, is especially suited for switching mode base drive and transistor circuits. The device is also intended for use as a free wheeling diode in power supplies and other power switching applications in automotive functions.

Table 1. Devi	ce summary

Symbol	Value
I _{F(AV)}	3 A
V _{RRM}	200 V
T _j (max)	175 °C
V _F (typ)	0.72 V
T _{rr} (typ)	16 ns

Features

- Low conduction losses
- Negligible switching losses
- Low forward and reverse recovery times
- High junction temperature
- AEC-Q101 qualified
- ECOPACK[®]2 compliant component
- PPAP capable

This is information on a product in full production.

Characteristics 1

Table 2. Absolute ratings (limiting values at $T_j = 25$ °C, unless otherwise specified)

Symbol	Parameter	Value	Unit		
V _{RRM}	Repetitive peak reverse voltage	200	V		
I _{F(AV)}	Average forward current, square waveform	3	А		
I _{FSM}	Surge current non repetitive forward current	t _p = 8.3 ms sinusoidal	80	А	
T _{stg}	T _{stg} Storage temperature range-65 to + 175°C				
T _j ⁽¹⁾	Operating temperature range-40 to + 175°C				
1. dPtot	$<\frac{1}{D^{th}(i_{0})}$ condition to avoid thermal runaway for a d	iode on its own heatsink			

 $<\frac{1}{\text{Rth(j-a)}}$ condition to avoid thermal runaway for a diode on its own heatsink dTj

Table 3. Thermal resistance

Symbol	Parameter	Тур.	Max.	Unit
R _{th(j-l)}	Junction to lead	15	23	°C/W

Symbol	Parameter	Tests co	onditions	Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V - V			1.6	
'R`´	R [*] Reverse leakage current	T _j = 125 °C	$V_R = V_{RRM}$		2	16	μA
V _F ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 3A		0.91	1.02	V
¥ F`´	V _F ⁽²⁾ Forward voltage drop	T _j = 150 °C	1F – 5A		0.72	0.83	v

Table 4. Static electrical characteristics

1. Pulse test: tp = 5 ms, δ < 2%

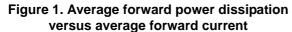
2. Pulse test: tp = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation: $P = 0.71 \text{ x } I_{F(AV)} + 0.04 \text{ x } I_{F^{2}(RMS)}$



Symbol	Parameter	Tests conditions			Тур.	Max.	Unit
		T _j = 25 °C	I _F = 1 A, dI _F /dt = -100 A/μs, V _R = 30 V		16	21	
t _{rr}	Reverse recovery time	1 _j =25 C	$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s},$ $V_R = 30 \text{ V}$		23		ns
		T _j = 125 °C	I _F = 3 A, dI _F /dt = 200 A/μs, V _R = 160 V		24		
Q _{RR}	Reverse recovery charge	T 125 °C	I _F = 3 A, dI _F /dt = -200 A/µs,		50		nC
I _{RM}	Reverse recovery current	1j = 125 C	$ P_{\rm R} = 3 \text{ A, } dI_{\rm F}/dt = -200 \text{ A/}\mu\text{s}, \\ V_{\rm R} = 160 \text{ V} $		3.5		А

Table 5. Dynamic electrical characteristics



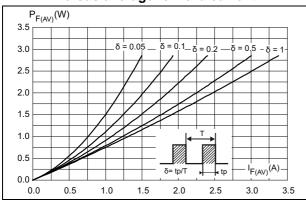
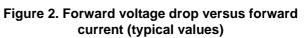


Figure 3. Forward voltage drop versus forward current (maximum values)



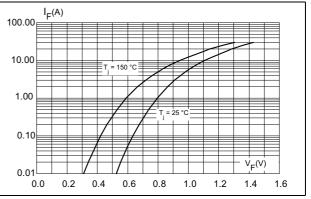


Figure 4. Relative variation of thermal impedance junction to lead versus pulse duration

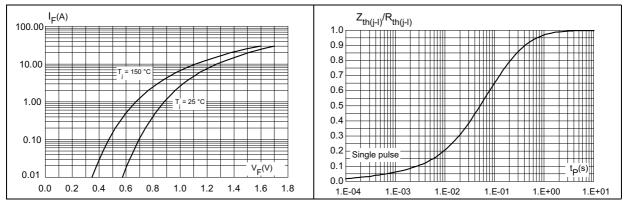




Figure 5. Reverse recovery charges versus dl_F/dt (typical values)

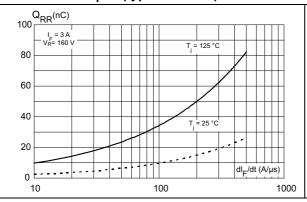


Figure 7. Peak reverse recovery current versus dI_F/dt (typical values)

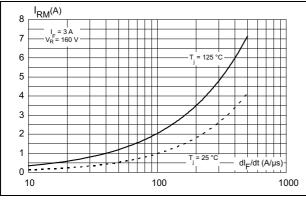
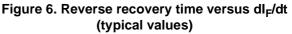


Figure 9. Junction capacitance versus reverse voltage applied (typical values)



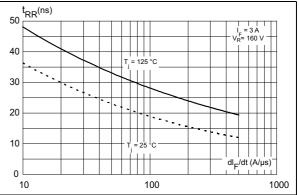


Figure 8. Dynamic parameters versus junction temperature

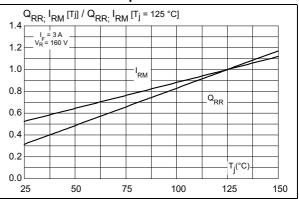
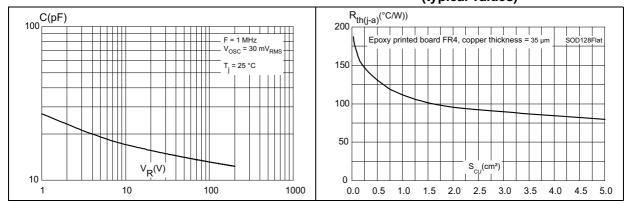


Figure 10. Thermal resistance junction to ambient versus copper surface under each lead (typical values)

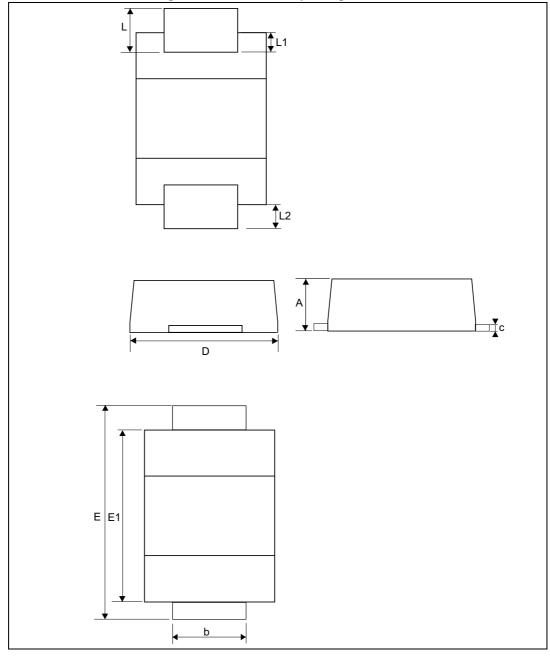




2 Package information

- Epoxy meets UL94,V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

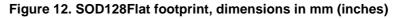


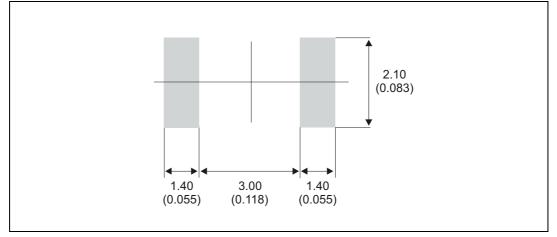




	Dimensions					
Ref.	Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	0.93		1.03	0.037		0.041
b	1.69		1.81	0.067		0.071
с	0.10		0.22	0.004		0.009
D	2.30		2.50	0.091		0.098
Е	4.60		4.80	0.181		0.189
E1	3.70		3.90	0.146		0.154
L	0.55		0.85	0.026		0.033
L1		0.30			0.012	
L2		0.45			0.018	

Table 6. SOD128Flat package mechanical data







3 Ordering information

Table 7	Ordering in	nformation
10.010	••••••••••••••••••••••••••••••••••••••	

Order codes	Marking	Package	Weight	Base qty	Delivery mode
STTH3R02AFY	3R2AY	SOD128Flat	26.4 mg	3000	Tape and reel

4 Revision history

Table 8. Document revision history

Date	Revision	Changes
24-Feb-2015	1	Initial release.



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